

## CERTIFICATE OF TRANSMISSION BY FACSIMILE (37CFR1.8)

**PLEASE DELIVER TO EXAMINER R. E. SELLERS**RECEIVED  
CENTRAL FAX CENTER  
DEC 14 2005Docket No. END920030022US1 (IEN-10-5752)Applicant(s): Thiel

Serial No.	Filing Date	Examiner	Group Art Unit
<u>10/688.689</u>	<u>October 16, 2003</u>	<u>R. E. Sellers</u>	<u>2379</u>

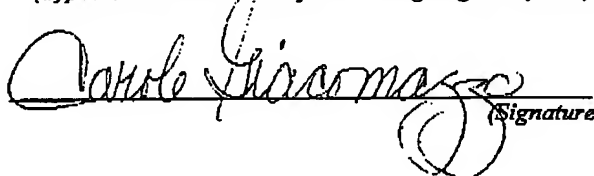
## Invention:

METHOD AND STRUCTURE FOR SELF HEALING CRACK MATERIAL BETWEEN AN  
I/C CHIP AND A SUBSTRATE BONDED TOGETHER WITH SOLDER BALLSI hereby certify that this Amendment is being transmitted via facsimile to the United States  
Patent and Trademark OfficeFax. No. 571-273-8300 on DECEMBER 14, 2005 6  
(Date) (No. of pages)

TO: Examiner Sellers

Attached is an Amendment being filed in response to the examiner's action of December  
5, 2005 and in accordance with the telephone interview on December 12, 2005. It is not believed  
that any fees are required.However, the Commissioner is hereby authorized to charge payment of fees associated  
with this communication, or credit any overpayment, to Deposit Account No. 09-0457.FROM: William N. Hogg  
CUSTOMER NO. 26681Carole Giacomazzo

(Typed or Printed Name of Person Signing Certificate)

  
(Signature)

END920030022US1 (IEN-10-5752)

**RECEIVED  
CENTRAL FAX CENTER****DEC 14 2005****PATENT****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of Thiel	)	Examiner: R. E. Sellers
	)	
Serial No. 10/688,689	)	Art Unit: 1712
	)	
Filed: October 16, 2003	)	Confirmation No. 2379
	)	
For: <b>METHOD AND STRUCTURE FOR SELF</b>	)	
<b>HEALING CRACK MATERIAL BETWEEN</b>	)	
<b>AN I/C CHIP AND A SUBSTRATE BONDED</b>	)	
<b>TOGETHER WITH SOLDER BALLS</b>	)	

Docket No. END920030022US1 (IEN-10-5752)

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Examiner's letter of December 5, 2005, kindly amend the claims as shown in the attached sheets.